

Cross Talk in Peta-Byte Interconnect

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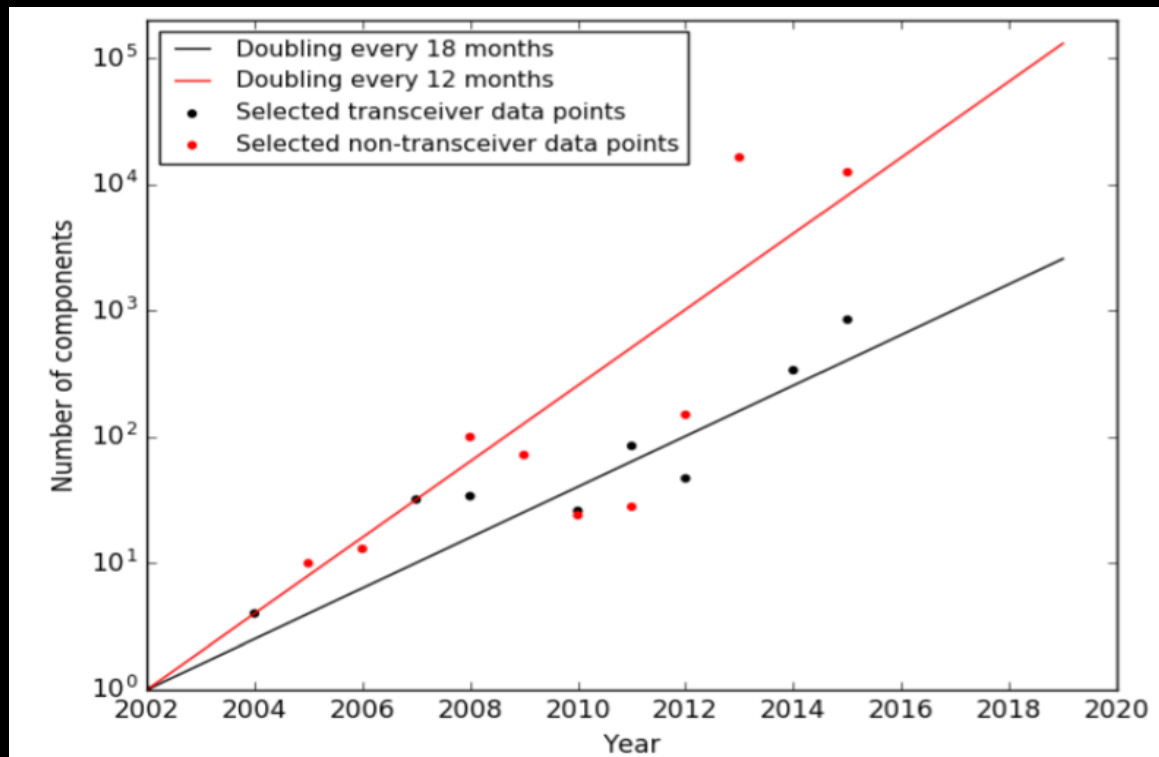
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Guided Wave Optics Lab

University of Colorado at Boulder



Silicon Photonics Complexity



How much complexity
does HPC require?

An Accelerator for AI

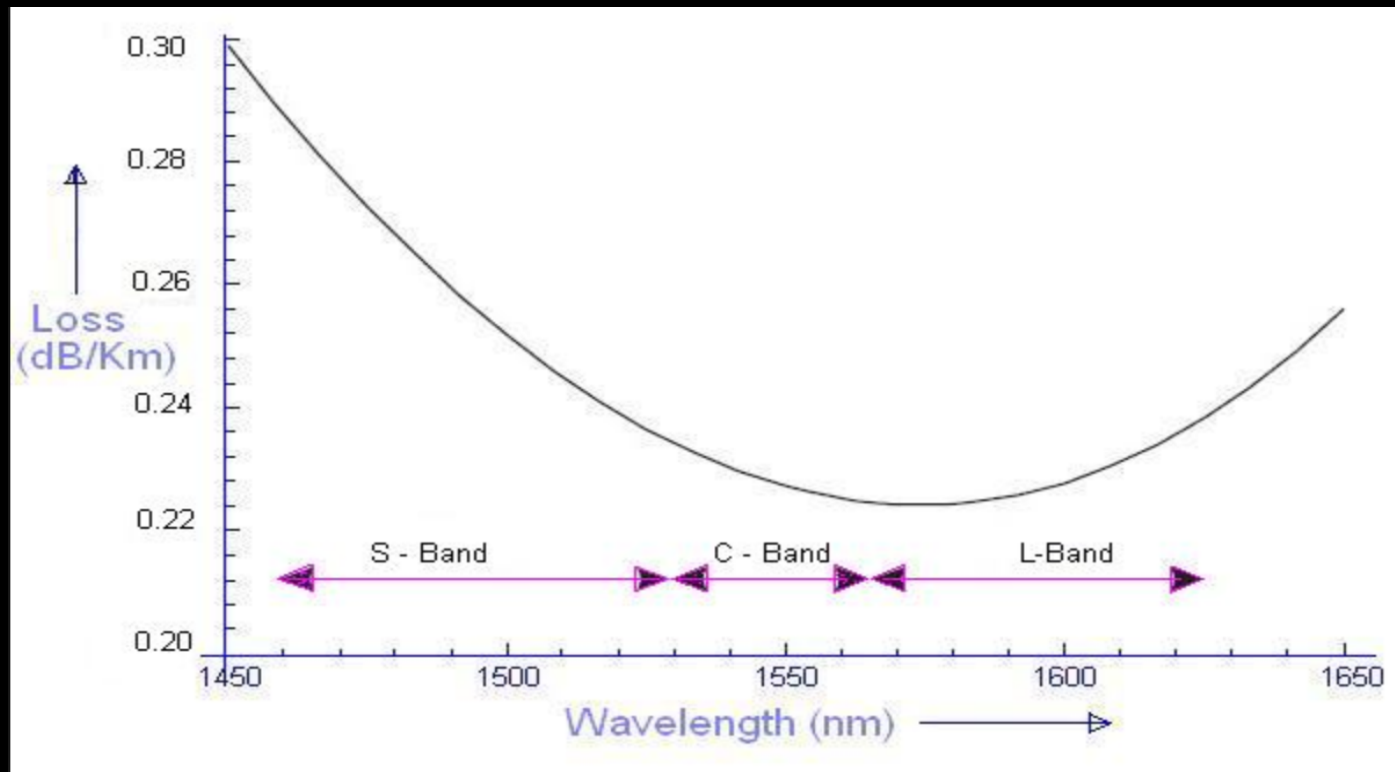


NVIDIA TESLA V100

CT BW 120 Tbps

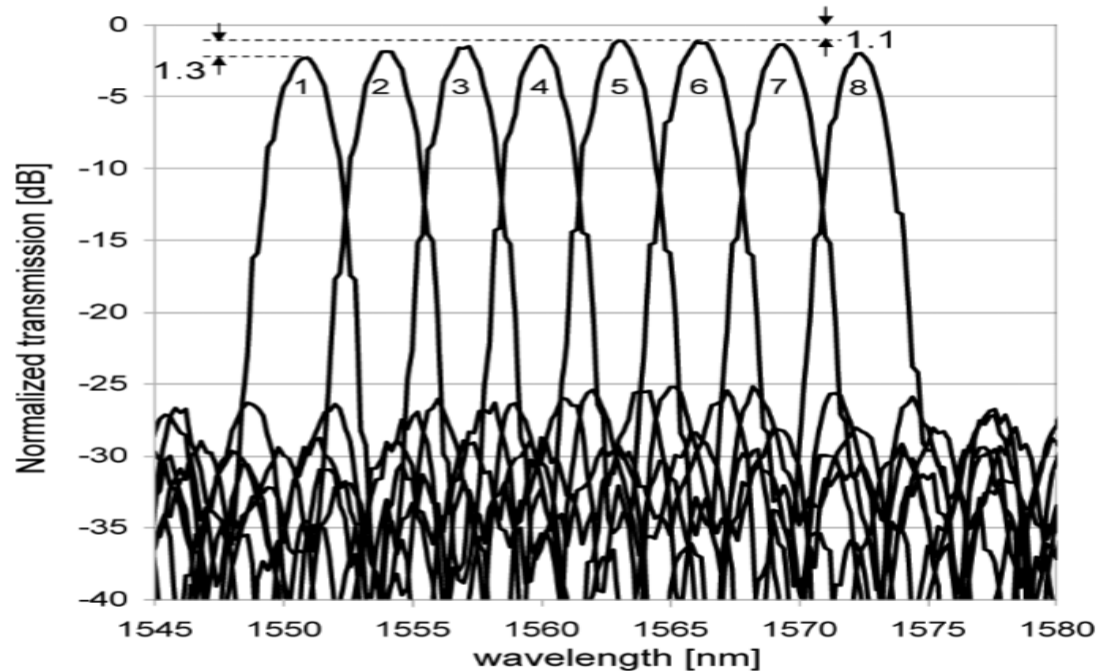
Bus 2.4 Tbps

Wavelength and Information?



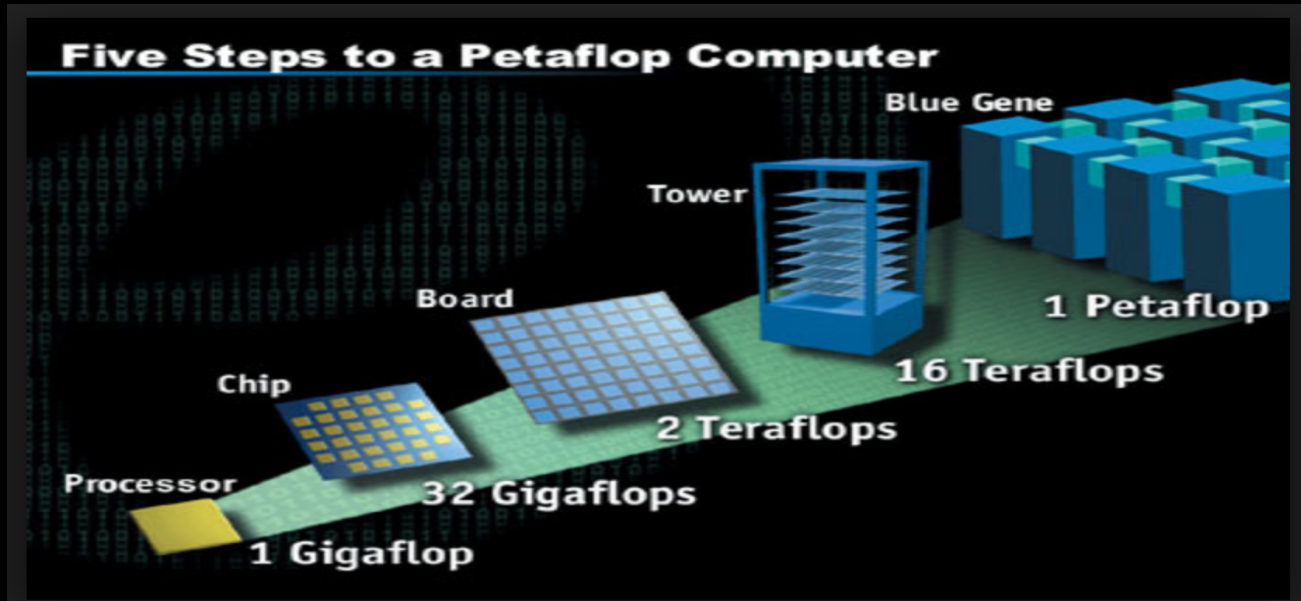
C+L is roughly 12 THz
(1nm = 125 GHz @ 1550nm)

DWDM



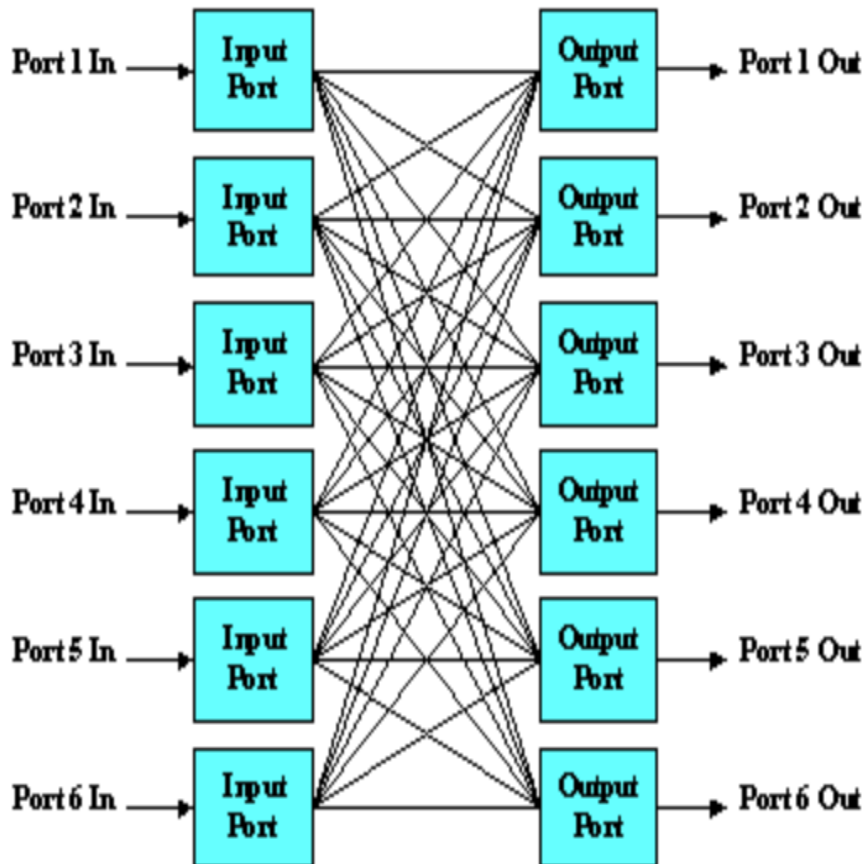
20% use of C+L is 2.5 Tbps
 $2.5 \text{ Tbps} = 50 \times 50 \text{ Gbps}$

How Big is a Peta Byte per second?



1.25 PBps is 4000 2.5 Tbps
4000 x 50 50 Gbps Channels

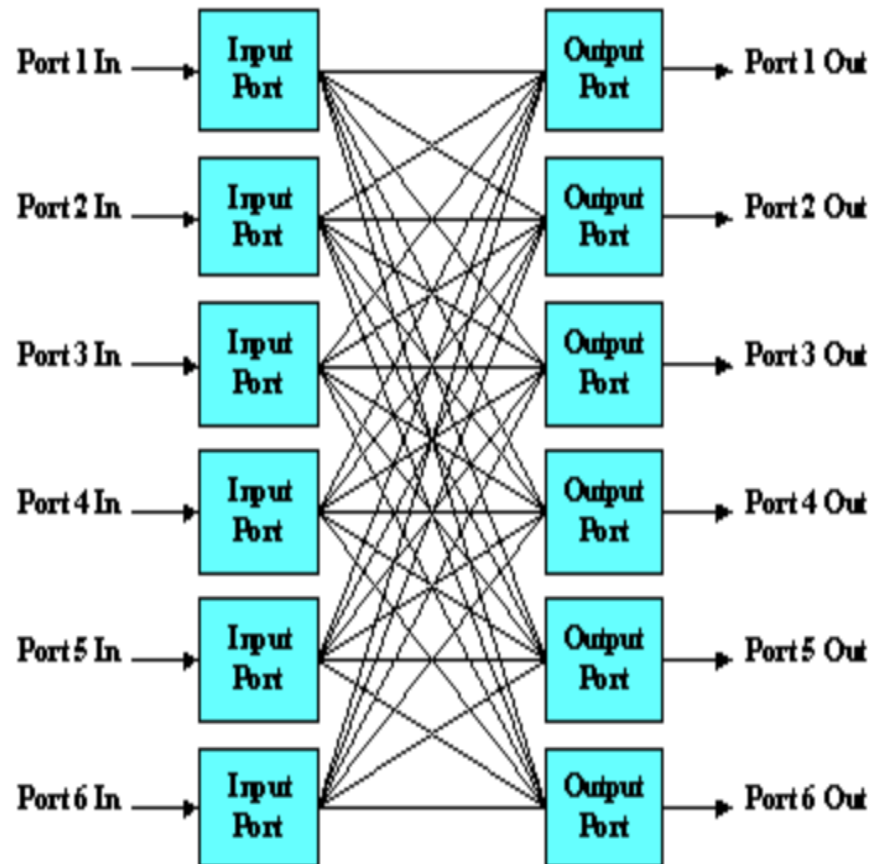
Memory Peta Byte Interconnect



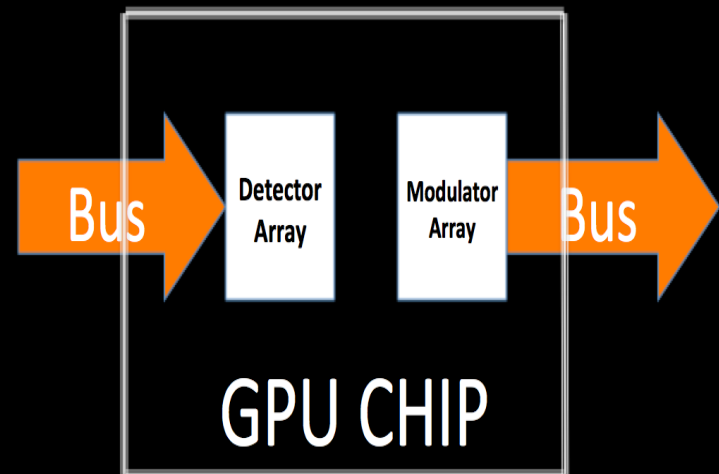
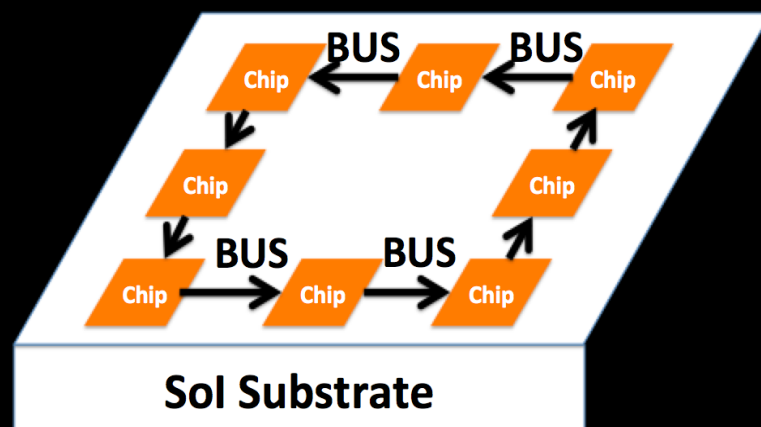
64 x 64
Crossbar
requires
4032 2.5
Tbps
channels

Memory Peta Byte Interconnect II

2.5 Tbps
requires 50
modulators
and 50
detectors
at each chip



How Big is a 50 Modulator Array?



4000 wg's -> 3.6 mm
Array limited by crosstalk

Modulator Crosstalk Studies

JW2A.132.pdf

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Experimental Study of Electro-Optic Crosstalk in Parallel Silicon Photonic Mach-Zehnder Modulators

^{1,2}Lingjun Jiang, ¹Xi Chen, ¹Kwangwoong Kim, ¹Guilhem de Valicourt,
²Zhaoran Rena Huang and ^{1,*}Po Dong

¹Bell Laboratories, Nokia, 791 Holmdel Road, Holmdel, NJ 07733, USA

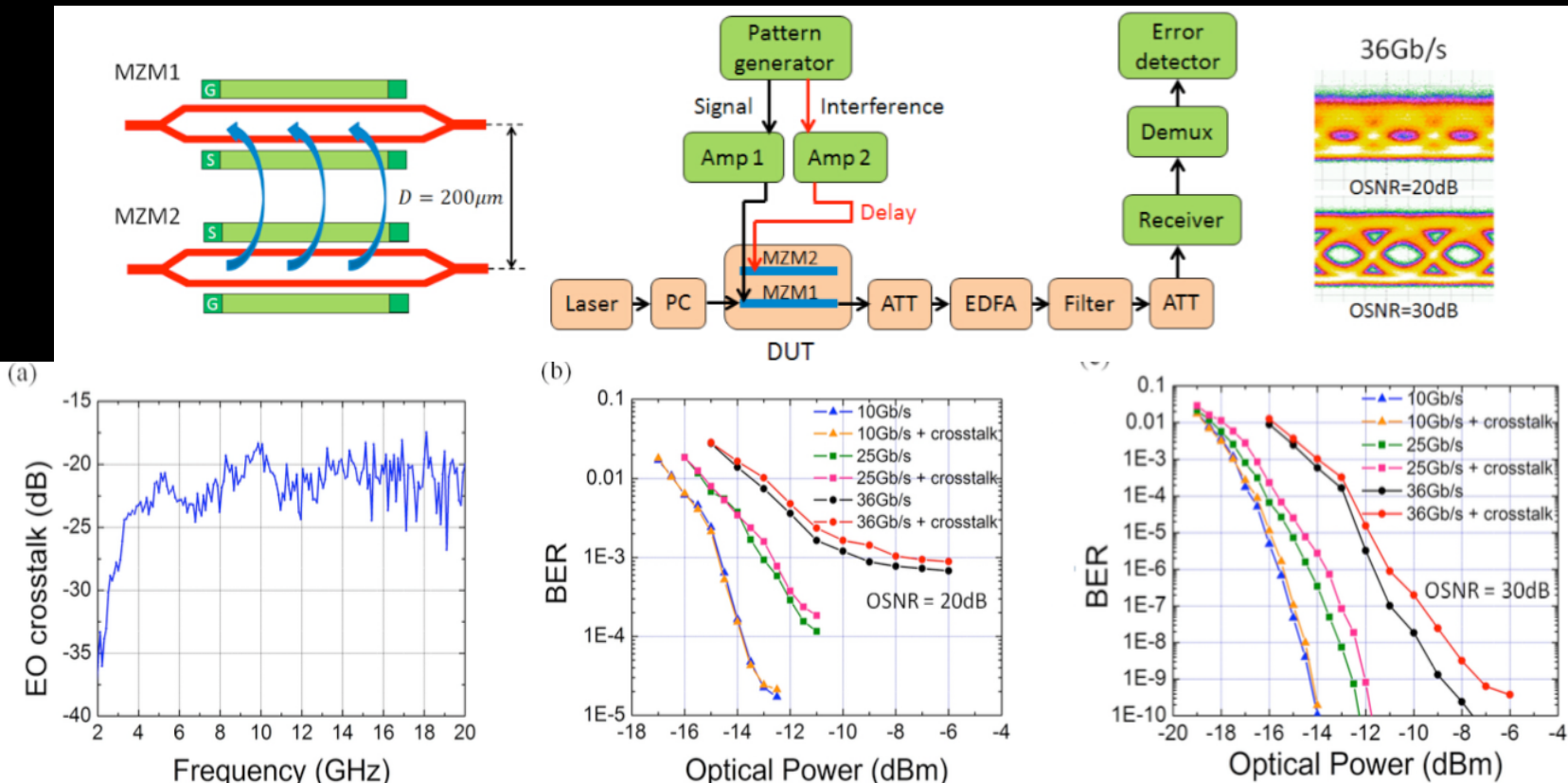
²Department of Electrical, Computer and Systems Engineering, Rensselaer Polytechnic Institute, 110 8th Street, Troy, NY12180, USA
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Experimental and Numerical Study of Electrical Crosstalk in Photonic-Integrated Circuits

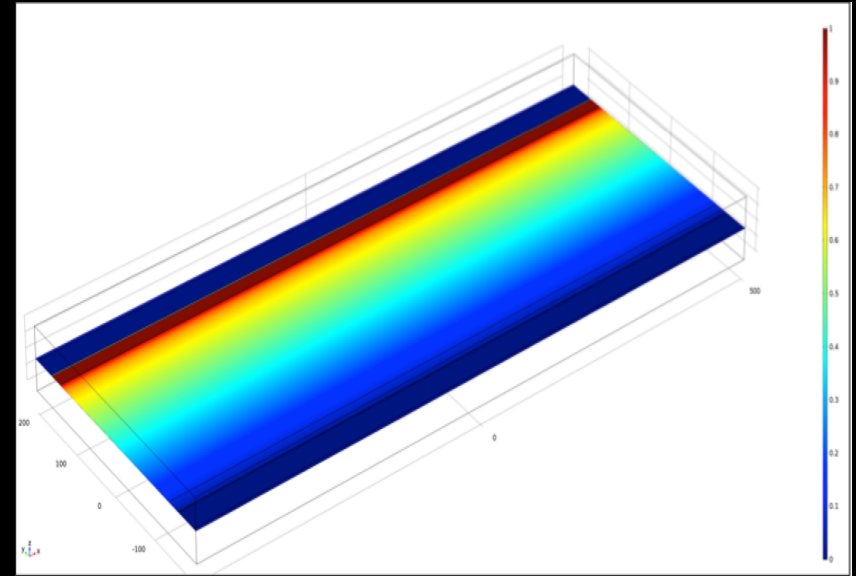
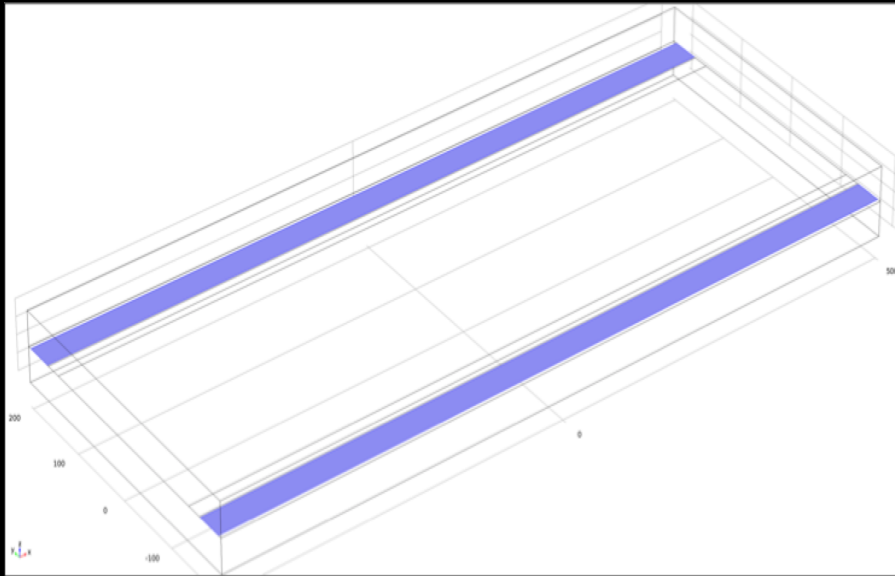
Weiming Yao, Giovanni Gilardi, Nicola Calabretta, *Member, IEEE*, Meint K. Smit,
and Michael J. Wale, *Member, IEEE, Member, OSA*

Results from Jiang et al. 2017



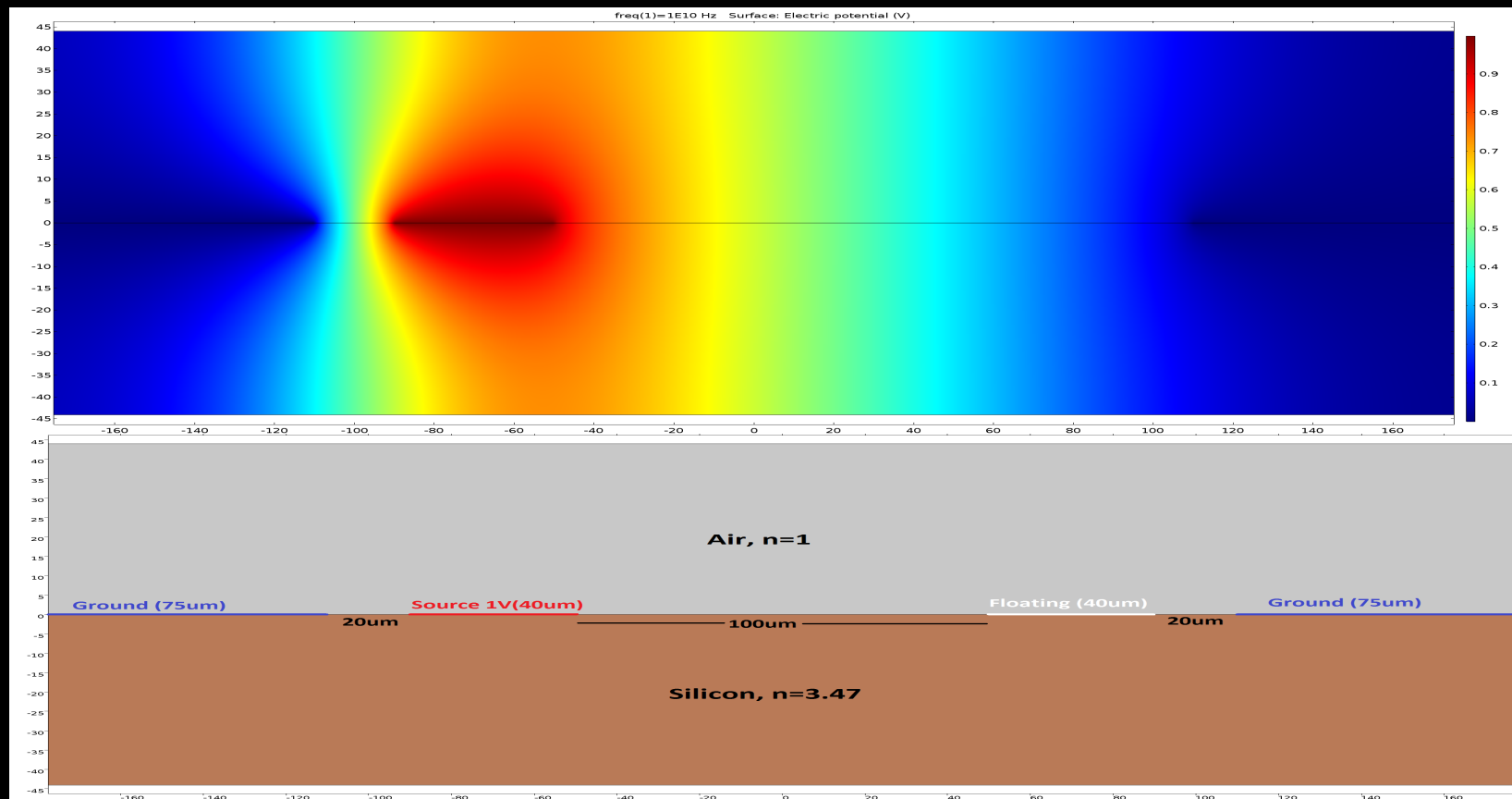
S to S crosstalk is disastrous

Our Model



S to S crosstalk is disastrous

Our Calculations (Linear Scale)



Shows circa 0.1

CPW from Yao et al. 2015

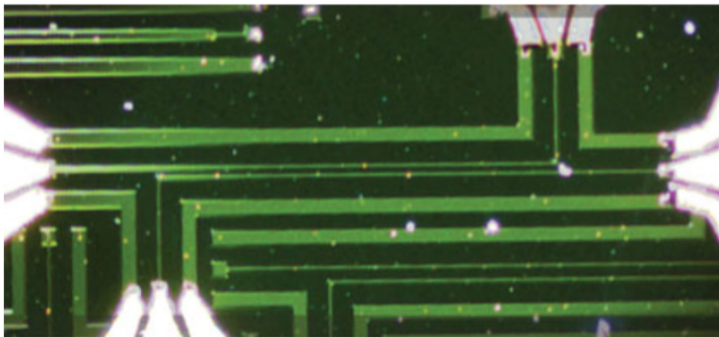
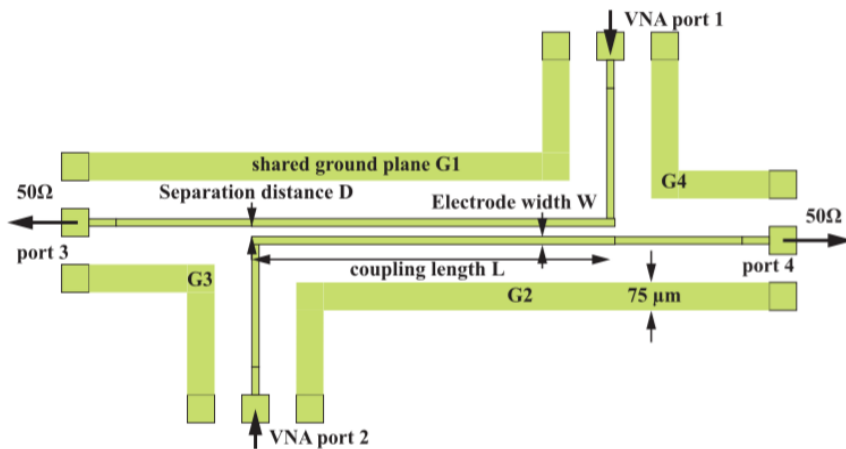
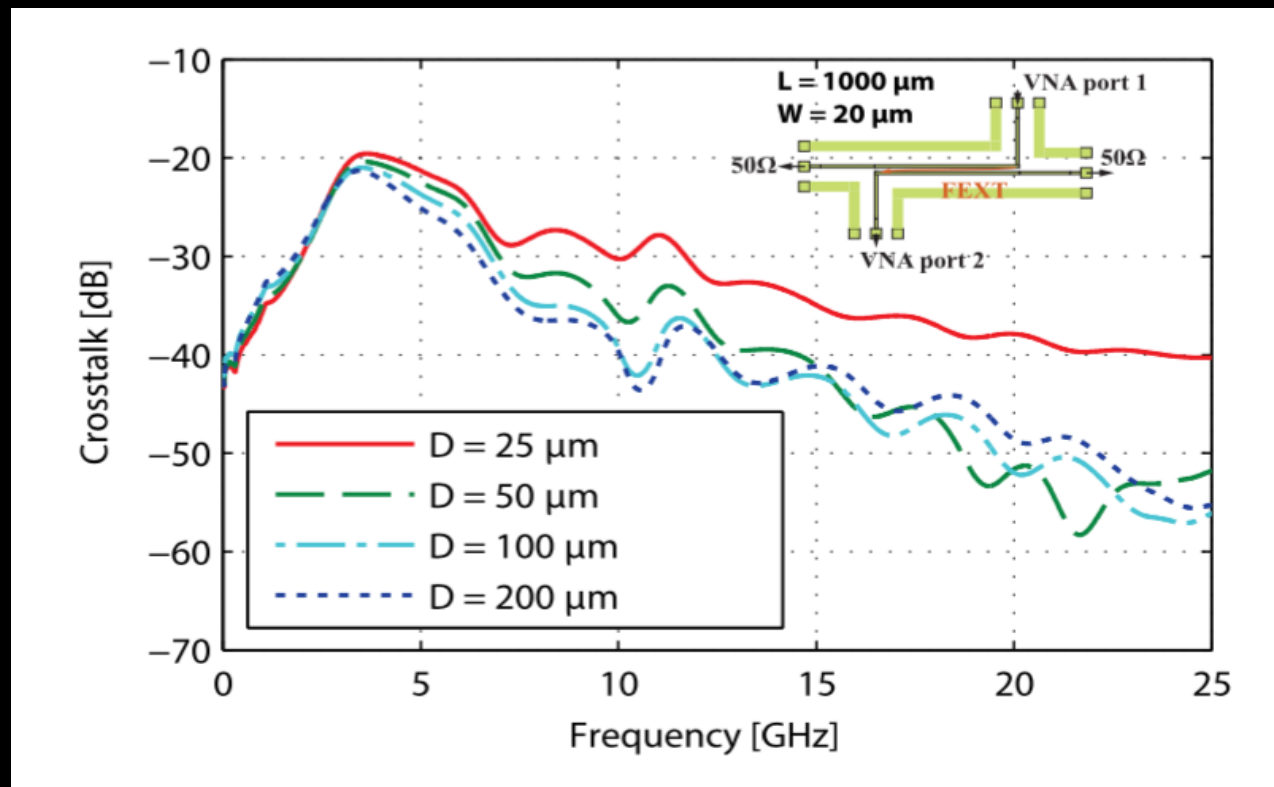


TABLE I
GEOMETRICAL PARAMETERS OF TEST STRUCTURES

	RF interconnects	Phase-shifters
Separation distance D (μm)	25, 50, 100, 200	30, 80, 180, 280
Coupling length L (μm)	1000, 2000	1250
Electrode width W (μm)	10, 20	20
Ground width G2-G4 (μm)	75	25
Ground width G1 (μm)	75	25 (D=30, D=80 μm)
Ground width G1' (μm)		35 (D=180, D=280 μm)
Ground length G1, G2 (μm)	1800	1500
Ground length G3, G4 (μm)	800, 825, 875, 975 (in order of incr. D)	260, 310, 410, 510 (in order of incr. D)

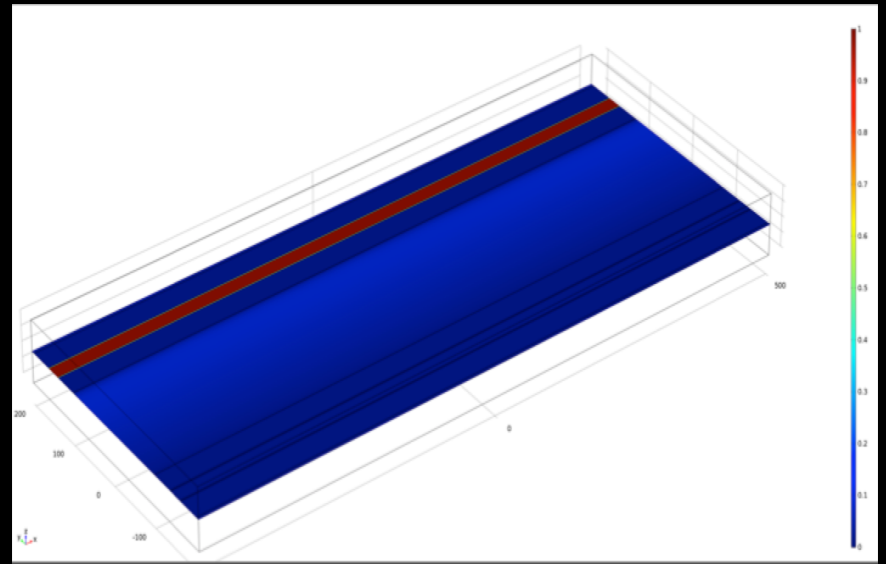
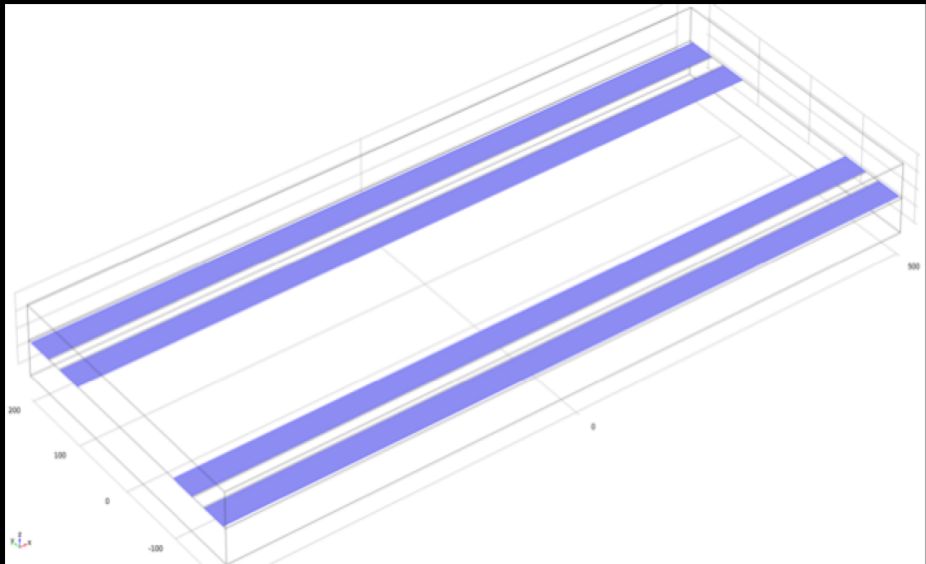
Is CPW Advantageous?

Results from Yao et al. 2015



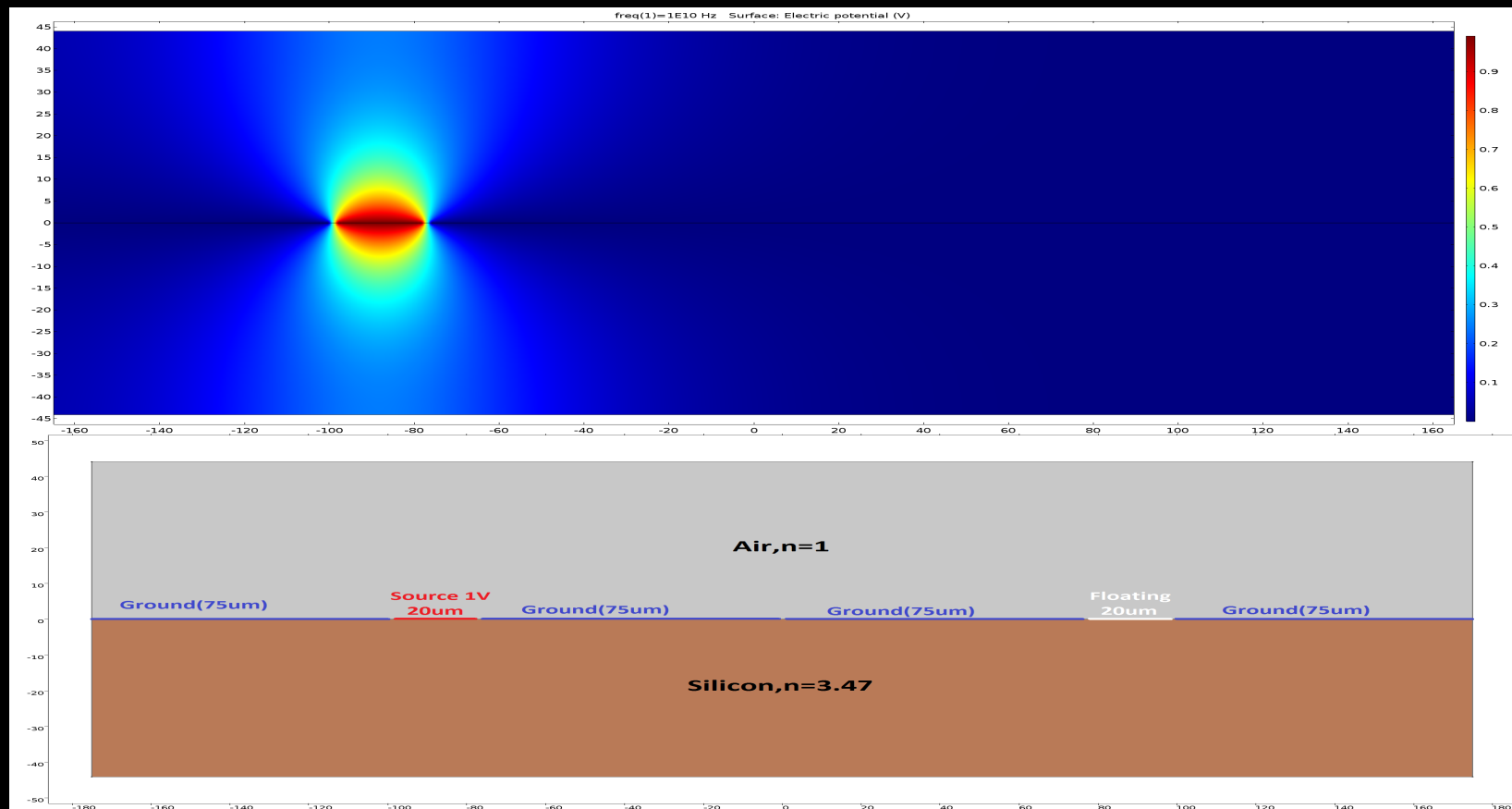
5 GHz is still problematic

Our CPW Jiang-Like Model



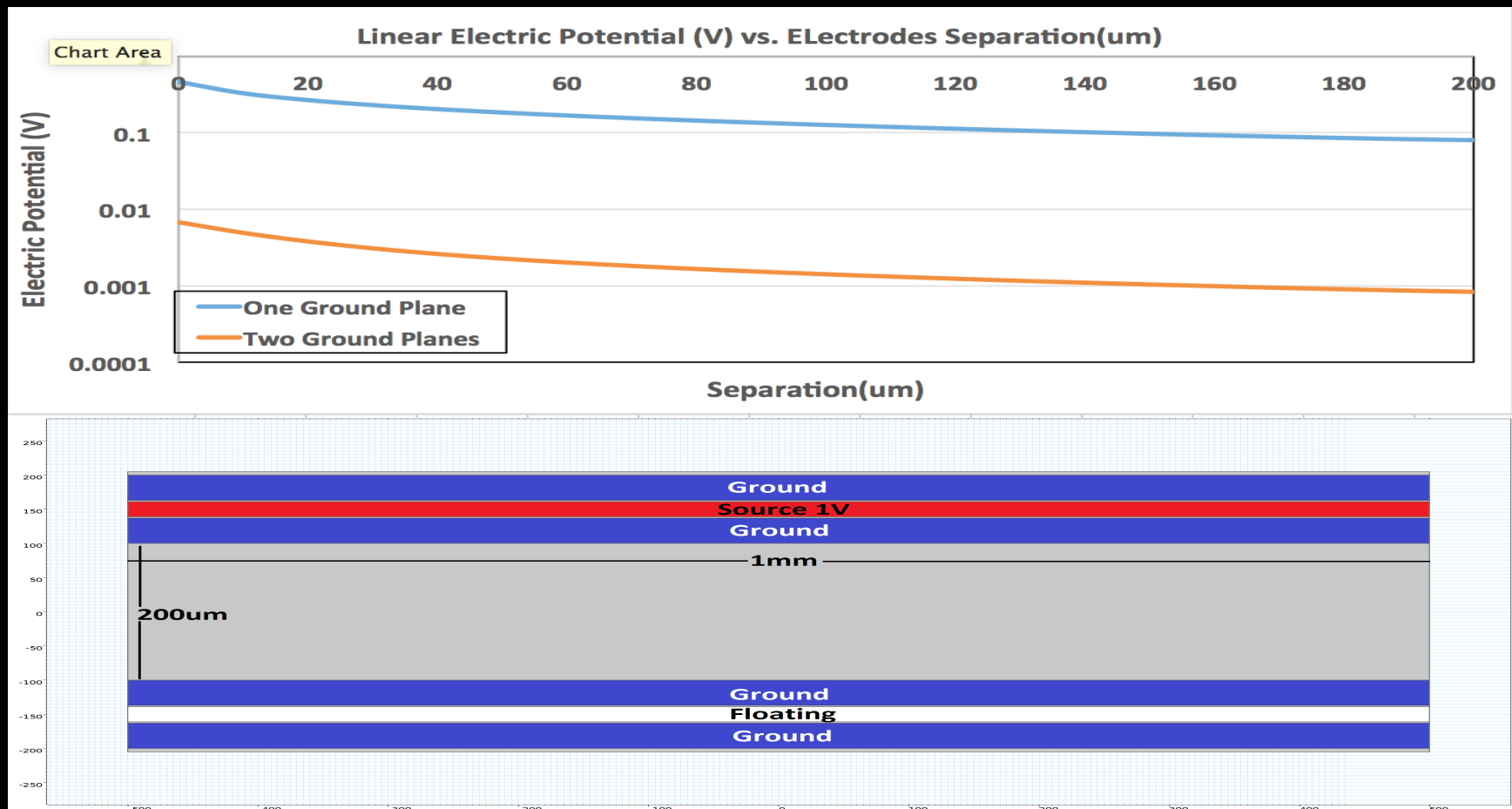
50 Ohm CPW

Our Calculations (Linear Scale)



Shows circa 0.001

Varying Separation



Grounds assumed 75 micron

Summary

- Crosstalk can be severe
- CPW is a compact solution
 - 50 Ohm CPW with 75 individual ground planes may be overkill

Questions?